

## Product Summary

BV <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C (Note 6)
-40V	25mΩ @ V <sub>GS</sub> = -10V	-8.6A
	45mΩ @ V <sub>GS</sub> = -4.5V	-7.0A

## Description

This MOSFET has been designed to minimize the on-state resistance yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

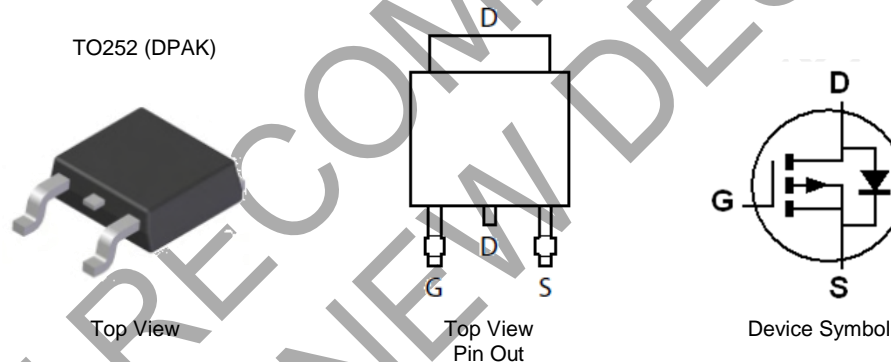
- Motor controls
- Backlighting
- DC-DC converters
- Printer equipment

## Features

- Low On-Resistance
- Fast Switching Speed
- Low Input/Output Leakage
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.  
<https://www.diodes.com/quality/product-definitions/>
- An automotive-compliant part is available under separate datasheet ([DMP4025LK3Q](#))

## Mechanical Data

- Package: TO252
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish - Matte Tin Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 Ⓔ
- Weight: 0.315 grams (Approximate)



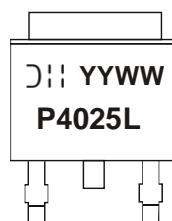
## Ordering Information (Note 4)

Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
DMP4025LK3-13	TO252 (DPAK)	P4025L	13	16	2,500	Reel

Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



311 = Manufacturer's Marking  
P4025L = Product Type Marking Code  
YYWW = Date Code Marking  
YY = Year (ex: 23 = 2023)  
WW = Week (01 to 53)

**Maximum Ratings** (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	-40	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	
Continuous Drain Current	V <sub>GS</sub> = -10V	(Note 6)	I <sub>D</sub>	-8.6	A
		T <sub>A</sub> = +70°C (Note 6)		-6.9	
		(Note 5)		-6.7	
Pulsed Drain Current	V <sub>GS</sub> = -10V	(Note 7)	I <sub>DM</sub>	-35	
Continuous Source Current (Body diode)		(Note 7)	I <sub>S</sub>	-8.6	
Pulsed Source Current (Body diode)		(Note 7)	I <sub>SM</sub>	-35	

**Thermal Characteristics** (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 5)	P <sub>D</sub>	1.7	W
	(Note 6)		2.78	
Thermal Resistance, Junction to Ambient	(Note 5)	R <sub>θJA</sub>	74	°C/W
	(Note 6)		45	
Thermal Resistance, Junction to Case	(Note 6)	R <sub>θJC</sub>	7.1	
Thermal Resistance, Junction to Lead	(Note 8)	R <sub>θJL</sub>	1.43	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

- Notes:
5. For a device surface mounted on minimum recommended FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
  6. Same as note (5), except the device is surface mounted on 25mm X 25mm X 1.6mm FR4 PCB.
  7. Repetitive rating on 25mm X 25mm FR4 PCB, D=0.02, pulse width 300μs – pulse width by maximum junction temperature.
  8. Thermal resistance from junction to solder-point (at the end of the drain lead).

## Thermal Characteristics

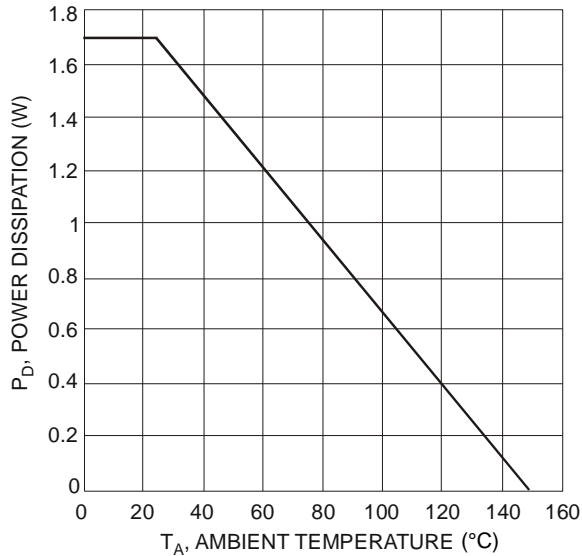


Figure 1. Power Dissipation vs. Ambient Temperature

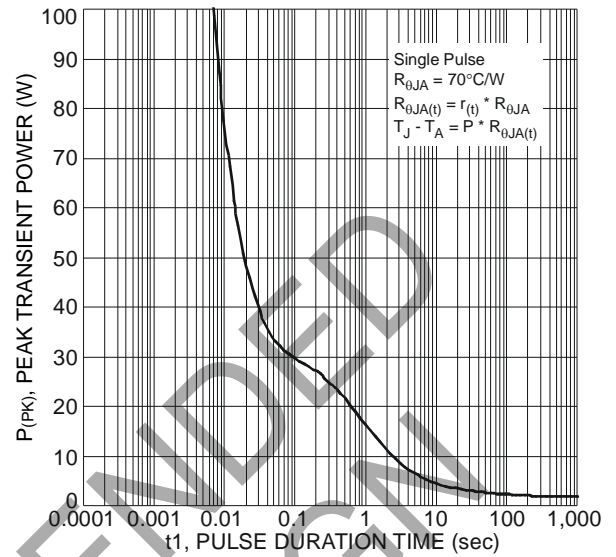


Figure 2. Single Pulse Maximum Power Dissipation

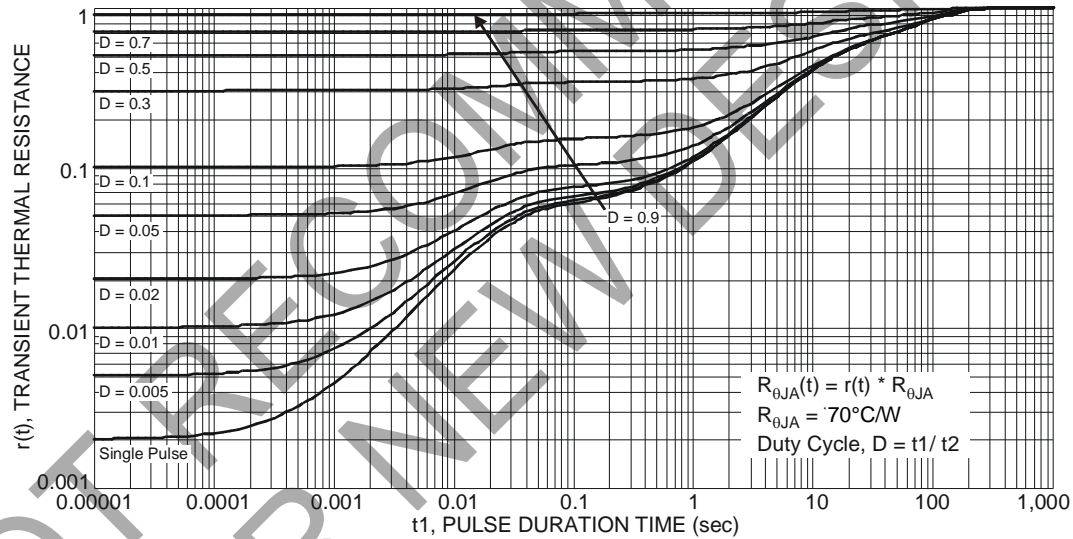


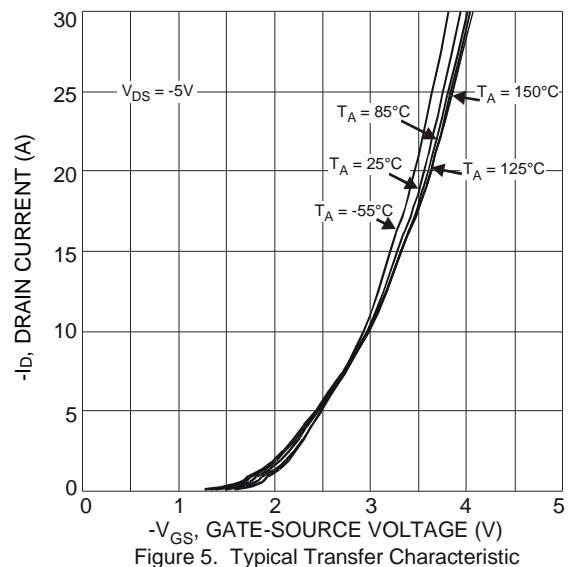
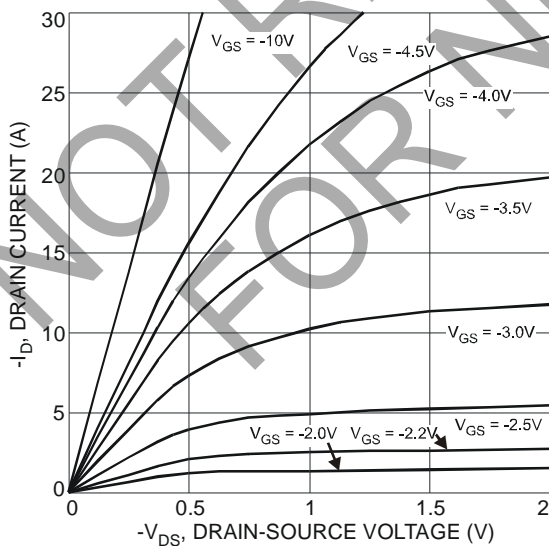
Figure 3. Transient Thermal Resistance

**Electrical Characteristics** (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-40	—	—	V	I <sub>D</sub> = -250μA, V <sub>GS</sub> = 0V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	-1	μA	V <sub>DS</sub> = -40V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	—	—	±100	nA	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.8	-1.3	-1.8	V	I <sub>D</sub> = -250μA, V <sub>DS</sub> = V <sub>GS</sub>
Static Drain-Source On-Resistance (Note 9)	R <sub>DS(ON)</sub>	—	18	25	mΩ	V <sub>GS</sub> = -10V, I <sub>D</sub> = -3A
			30	45		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3A
Forward Transconductance (Notes 9 & 10)	g <sub>fs</sub>	—	16.6	—	S	V <sub>DS</sub> = -5V, I <sub>D</sub> = -3A
Diode Forward Voltage (Note 9)	V <sub>SD</sub>	—	-0.7	-1	V	I <sub>S</sub> = -1A, V <sub>GS</sub> = 0V
<b>DYNAMIC CHARACTERISTICS (Note 10)</b>						
Input Capacitance	C <sub>iss</sub>	—	1643	—	pF	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V f = 1MHz
Output Capacitance	C <sub>oss</sub>	—	179	—		
Reverse Transfer Capacitance	C <sub>rss</sub>	—	128	—		
Gate Resistance	R <sub>g</sub>	—	6.43	—	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz
Total Gate Charge (Note 11)	Q <sub>g</sub>	—	14	—	nC	V <sub>GS</sub> = -4.5V V <sub>DS</sub> = -20V I <sub>D</sub> = -3A
Total Gate Charge (Note 11)	Q <sub>g</sub>	—	33.7	—		
Gate-Source Charge (Note 11)	Q <sub>gs</sub>	—	5.5	—		
Gate-Drain Charge (Note 11)	Q <sub>gd</sub>	—	7.3	—		
Turn-On Delay Time (Note 11)	t <sub>D(on)</sub>	—	6.9	—	ns	V <sub>DD</sub> = -20V, V <sub>GS</sub> = -10V I <sub>D</sub> = -3A
Turn-On Rise Time (Note 11)	t <sub>r</sub>	—	14.7	—		
Turn-Off Delay Time (Note 11)	t <sub>D(off)</sub>	—	53.7	—		
Turn-Off Fall Time (Note 11)	t <sub>f</sub>	—	30.9	—		

Notes: 9. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%.  
10. For design aid only, not subject to production testing.  
11. Switching characteristics are independent of operating junction temperatures.

**Typical Characteristics**



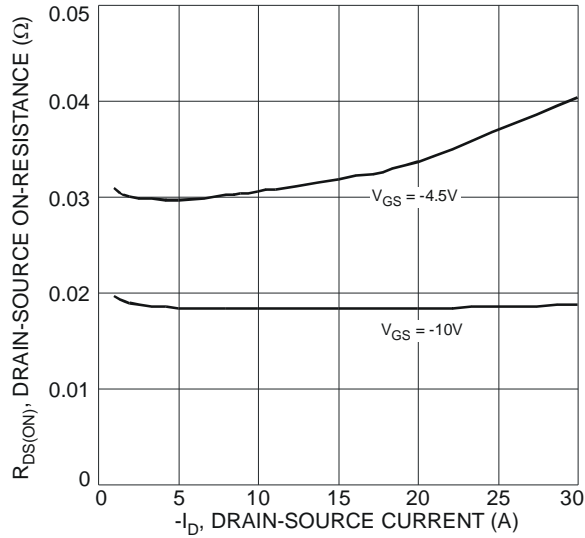


Figure 6. Typical On-Resistance vs. Drain Current and Gate Voltage

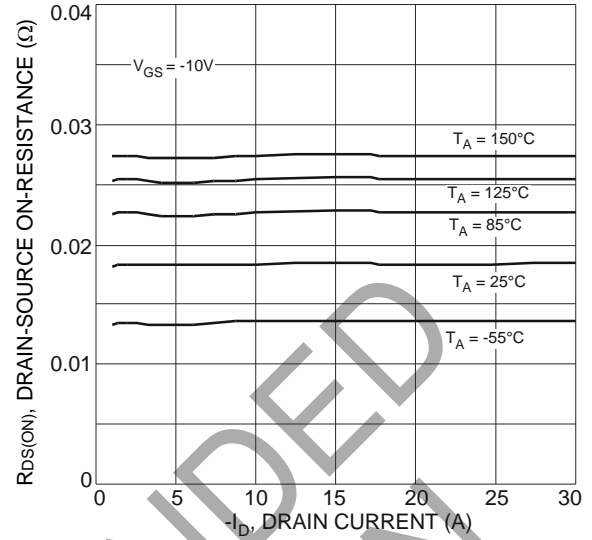


Figure 7. Typical On-Resistance vs. Drain Current and Temperature

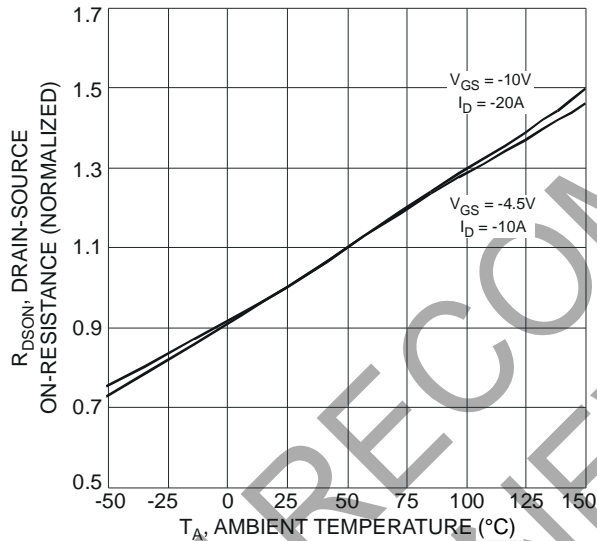


Figure 8. On-Resistance Variation with Temperature

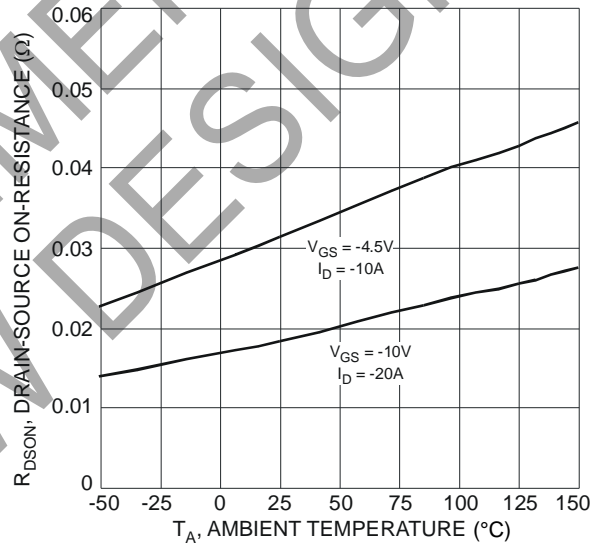


Figure 9. On-Resistance Variation with Temperature

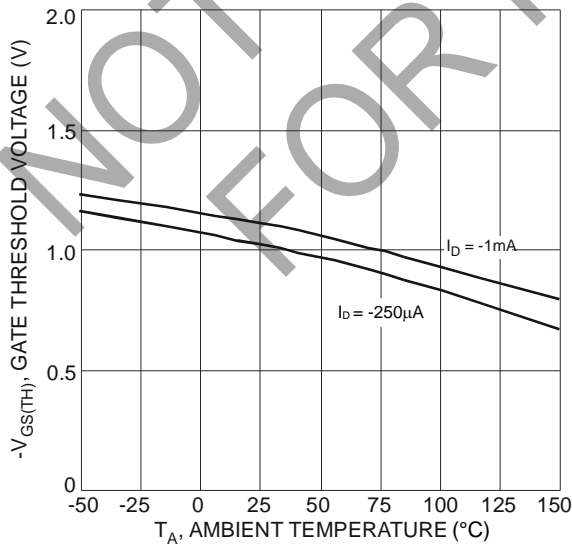


Figure 10. Gate Threshold Variation vs. Ambient Temperature

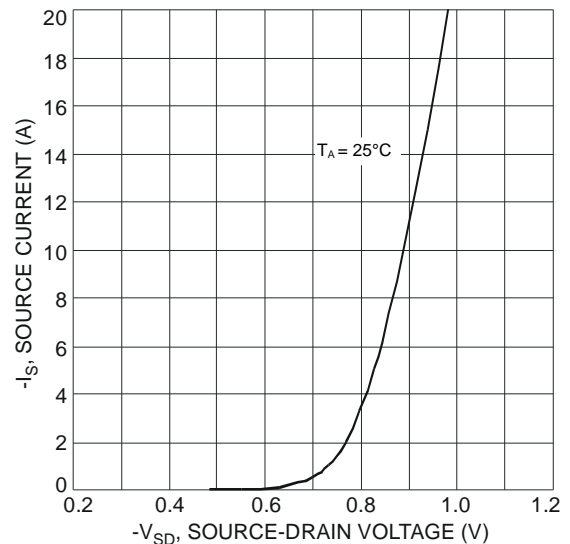
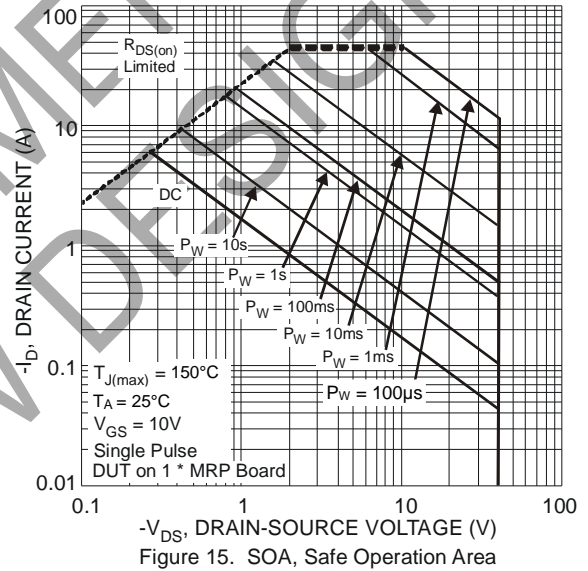
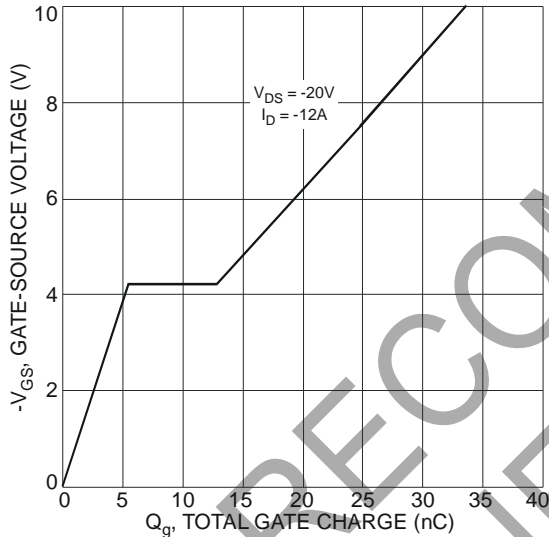
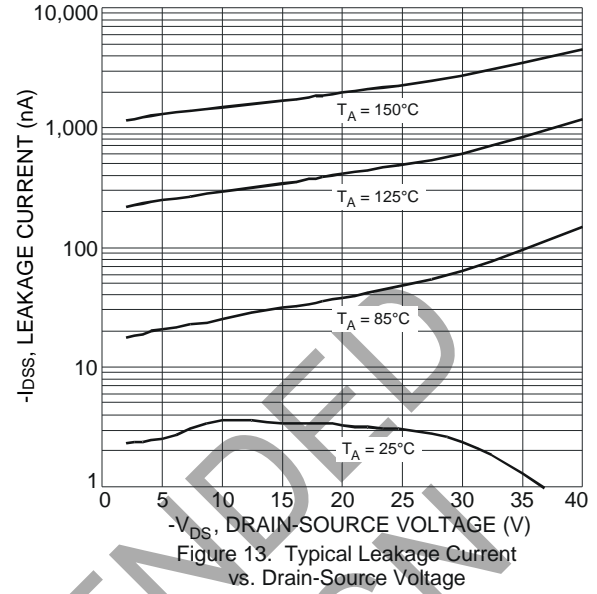
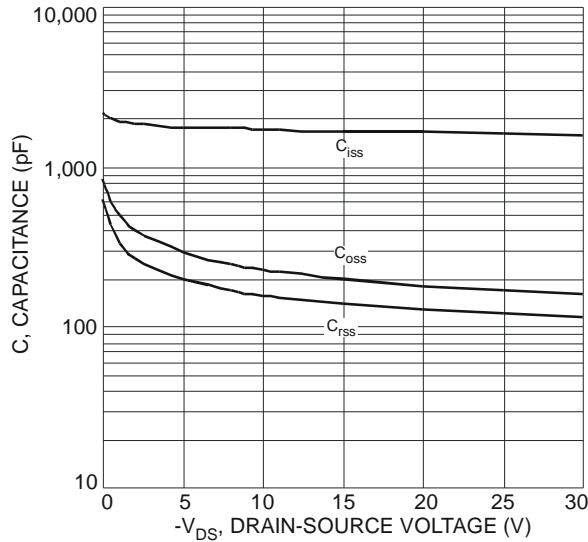


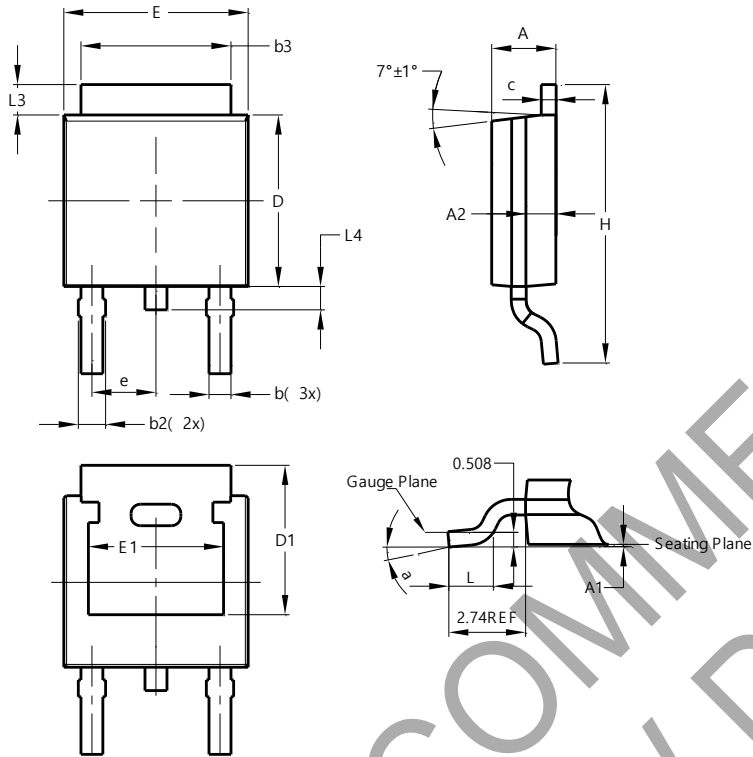
Figure 11. Diode Forward Voltage vs. Current



## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**TO252 (DPAK)**

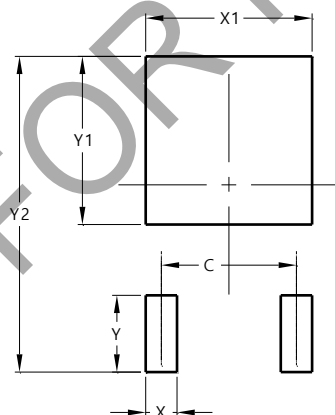


TO252 (DPAK)			
Dim	Min	Max	Typ
A	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.64	0.88	0.783
b2	0.76	1.14	0.95
b3	5.21	5.50	5.33
c	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	--	--
e	2.286 BSC		
E	6.45	6.70	6.58
E1	4.32	--	--
H	9.40	10.41	9.91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.64	1.02	0.83
a	0°	10°	--
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**TO252 (DPAK)**



Dimensions	Value (in mm)
C	4.572
X	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

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